



(12) **United States Design Patent**
Li

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(54) **SOLDERING IRON**
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(72) Inventor: **Junqiang Li**, Shenzhen (CN)
(**) Term: **15 Years**
(21) Appl. No.: **29/794,513**

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(51) **LOC (13) Cl.** **15-09**
(52) **U.S. Cl.**
USPC **D15/144.2; D8/30**
(58) **Field of Classification Search**
USPC D8/29.1, 29.2, 30; D15/144, 144.1,
D15/144.2; D24/144
CPC B23K 3/021; B23K 3/022; B23K 3/023;
B23K 3/033; B23K 3/023; B23K 3/0346
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a soldering iron, as shown and described.

DESCRIPTION

FIG. 1 is a front elevational view of a soldering iron showing my new design;
FIG. 2 is a rear elevational view thereof; and
FIG. 3 is a left side view thereof;
FIG. 4 is a right side view thereof;
FIG. 5 is a top plan view thereof;
FIG. 6 is a bottom plan view thereof; and,
FIG. 7 is a perspective view of a soldering iron showing my new design.

The broken lines in the figures are for the purposes of illustrating portions of the soldering iron, which form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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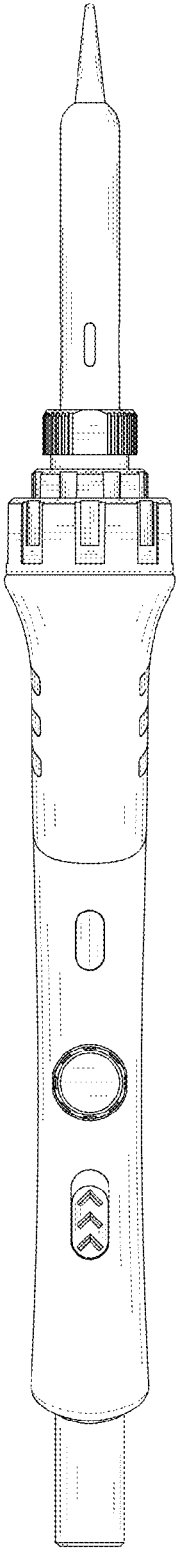


FIG. 1

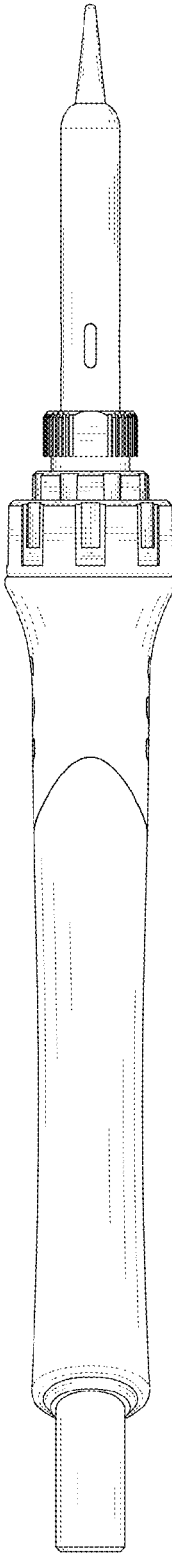


FIG. 2

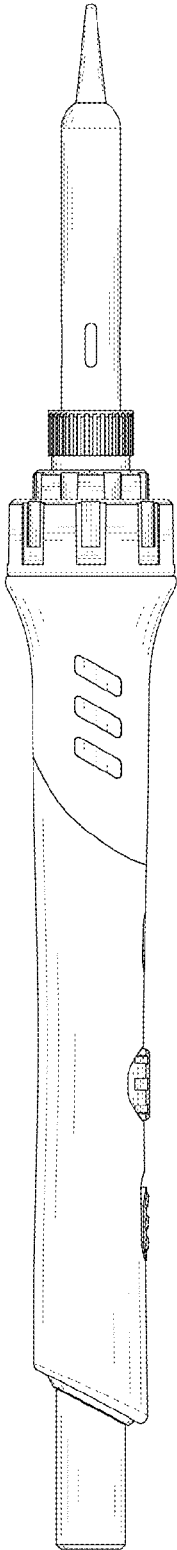


FIG. 3

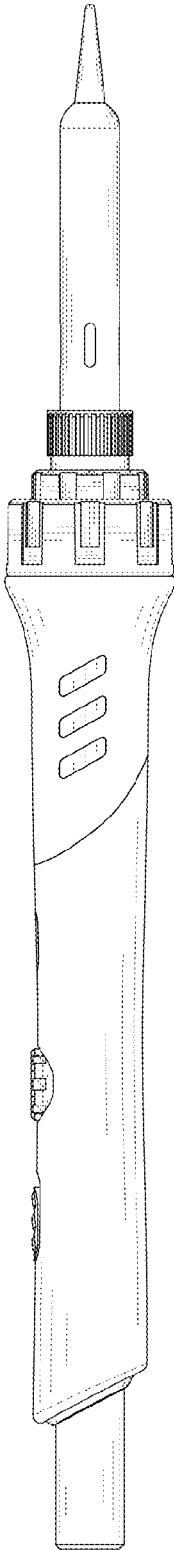


FIG. 4

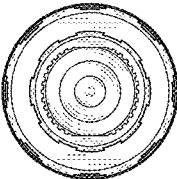


FIG. 5

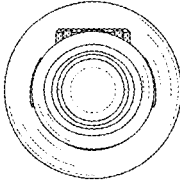


FIG. 6

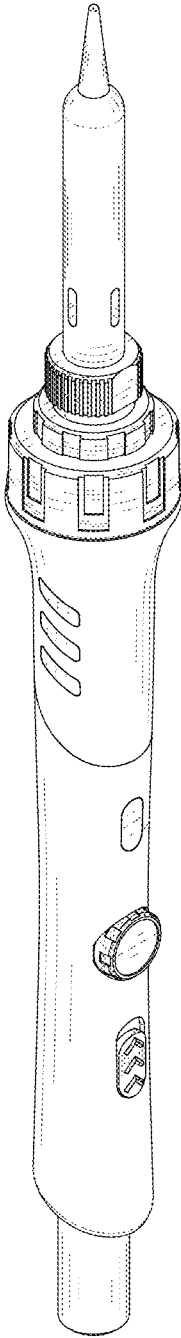


FIG. 7